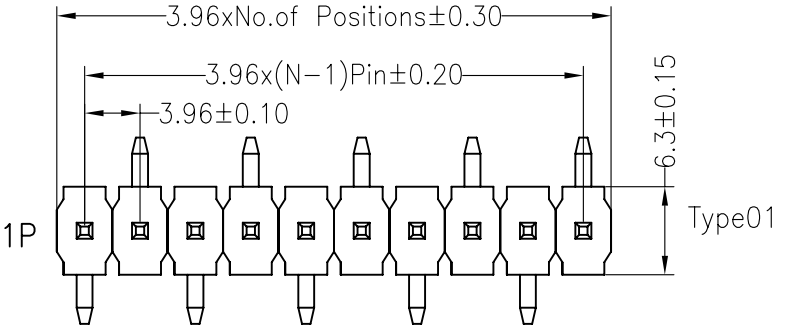
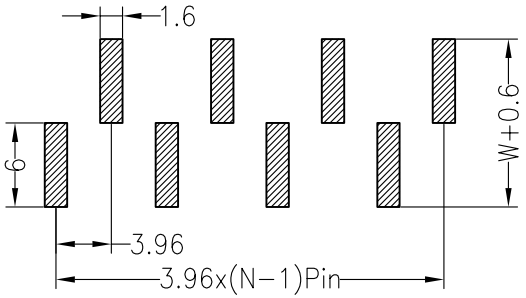
HSF RoHS

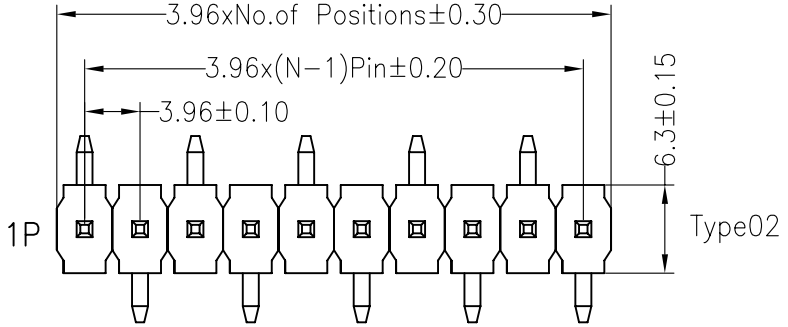
SPECIFICATIONS
Rated Current:5.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

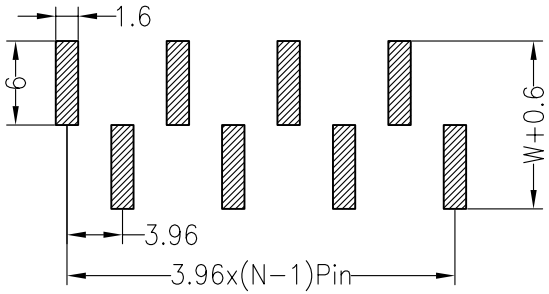
Contact Material:Brass
Contact Plating:Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: LCP
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 5 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



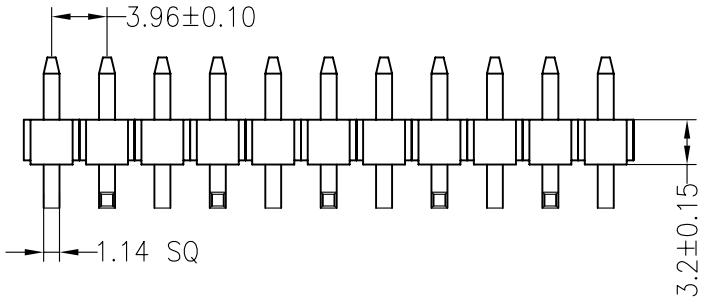


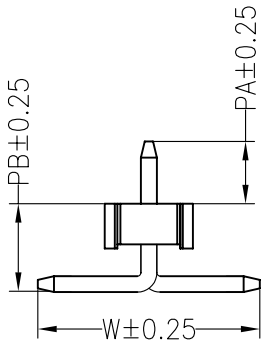


Ordering Information

1932 11 XX F N XX M XXX X 01(2)

- No.of Pins Per Row 1x1~1x20
- Insulator Material Option: A=BK−PBT, B=BK−PA66, C=BK−PA6T, D=BK−PA46, F=BK−LCP
- Contact Plating: G0:Gold Flash, G2:5U" Gold, G3:10U" Gold, G4:15U" Gold, G5:30U" Gold, S0:Gold Flash/Tin, SN:Tin, SM:Matte−Tin
- Pin Length
- Packing: 0=PE Bag, A=Tray, T=Tube, R=Reel+Cap





Dimension antitheses list				
ITEM	PA	PB	W	L
Standard	8.00	6.50	10.00	18.8
Alternate				

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.04.11	NEW DRAWING	

OPERATION		DRAW	Liu Miao	12.04.11
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	193211XXFNXXMXXXX01(2)
TITLE:	3.96PH 1xNpin H3.2mm SMT